
UNITED STATES
SECURITIES AND EXCHANGE COMMISSION
Washington, D.C. 20549

FORM 8-K

CURRENT REPORT
Pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): May 4, 2011

TTM TECHNOLOGIES, INC.

(Exact name of registrant as specified in its charter)

Delaware (State or other Jurisdiction of Incorporation)	0-31285 (Commission File Number)	91-1033443 (IRS Employer Identification No.)
2630 South Harbor Boulevard, Santa Ana, CA (Address of Principal Executive Offices)	92704 (Zip Code)	

Registrant's telephone number, including area code: **(714) 327-3000**

(Former name or former address if changed since last report.)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions:

- ☐ Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
 - ☐ Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
 - ☐ Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
 - ☐ Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))
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Item 8.01. Other Events.

On May 4, 2011, we announced our entry into a letter of intent to acquire the remaining 20% interest in Meadville Aspocomp (BVI) Holdings Ltd. from Aspocomp Group Plc (“Aspocomp”) for EUR14.5 million. Under this letter of intent, we also agreed to exchange our 10% stake in Aspocomp Oulu Oy for approximately 12.3 million shares of Aspocomp to be issued by Aspocomp for this exchange. Both the proposed transactions are subject to the signing and completion of definitive agreements.

Item 9.01. Financial Statements and Exhibits.*(a) Financial Statements of Business Acquired.*

Not applicable.

(b) Pro Forma Financial Information.

Not applicable.

(c) Shell Company Transactions.

Not applicable.

*(d) Exhibits.*Exhibit Number

99.1 Press release from TTM Technologies, Inc., dated May 4, 2011, entitled “TTM Technologies, Inc. To Acquire Remaining Stake In Meadville Aspocomp (BVI) Holdings Ltd.”

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

Date: May 10, 2011

TTM TECHNOLOGIES, INC.

By: /s/ Steven W. Richards
Steven W. Richards
Executive Vice President
and Chief Financial Officer

EXHIBIT INDEX

- 99.1 Press release from TTM Technologies, Inc., dated May 4, 2011, entitled “TTM Technologies, Inc. To Acquire Remaining Stake In Meadville Aspocomp (BVI) Holdings Ltd.”

**TTM TECHNOLOGIES, INC. TO ACQUIRE REMAINING STAKE IN MEADVILLE
ASPOCOMP (BVI) HOLDINGS LTD.**

SANTA ANA, CA – May 4, 2011 — TTM Technologies, Inc. (Nasdaq: TTMI), a major global printed circuit board (PCB) manufacturer, today announced that it has entered into a letter of intent to acquire the remaining 20 percent interest in Meadville Aspocomp (BVI) Holdings Ltd. ("MAH") from Finland-based Aspocomp Group Plc ("Aspocomp") for EUR14.5 million. Under this letter of intent, TTM also has agreed to exchange its 10 percent stake in Aspocomp Oulu Oy ("Oulu") for approximately 12.3 million shares of Aspocomp to be issued by Aspocomp for this exchange. Oulu is a PCB manufacturer based in Finland. Both the proposed transactions are subject to the signing and completion of definitive agreements.

MAH was established by Aspocomp in 2007 to hold its major PCB manufacturing operations in Asia. TTM's Asia Pacific business segment, which at the time was part of Meadville Holdings Ltd., acquired an 80 percent interest in MAH from Aspocomp in late 2007 with an agreement to purchase the remaining 20 percent as early as January 2013. By agreeing to purchase the remaining stake early, TTM will receive a discount of approximately EUR 2.9 million to the minimum price. The transaction is not expected to impact TTM's earnings per share as the company has historically included MAH's results in its financial statements.

About TTM

TTM Technologies, Inc. is a major global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs and the backplane and sub-system assembly business. TTM stands for time-to-market, representing how the company's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at www.ttmtech.com.

Safe Harbor Statement

This release contains forward-looking statements that relate to future events or performance. These statements reflect the company's current expectations, and the company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the forward-looking statements. These risks and uncertainties include, but are not limited to, the company's dependence upon the electronics industry, the impact of the current economic crisis, the company's dependence upon a small number of customers, the unpredictability of and potential fluctuation in future revenues and operating results, increased competition from low-cost foreign manufacturers and other "Risk Factors" set forth in the company's most recent SEC filings.